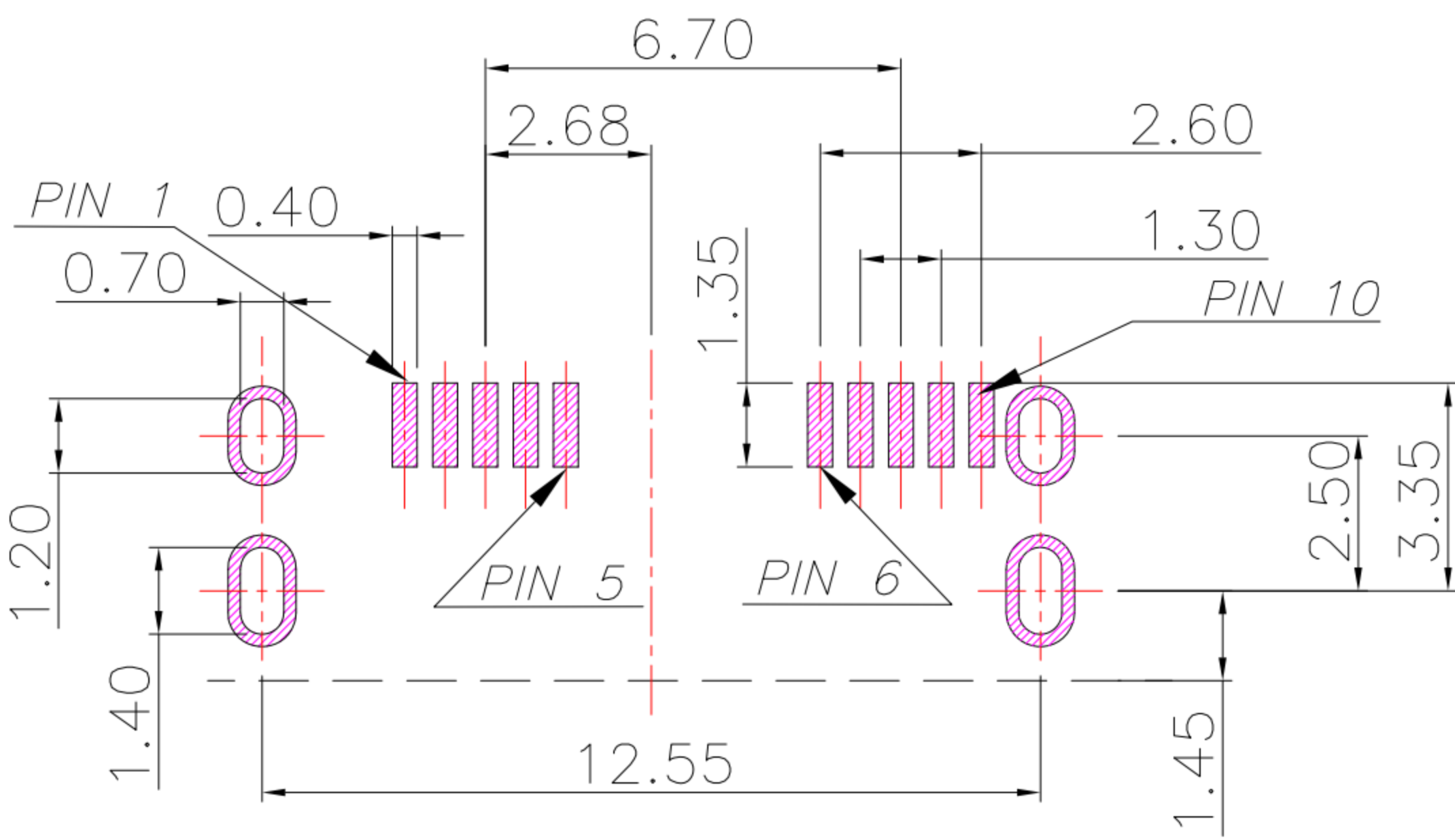
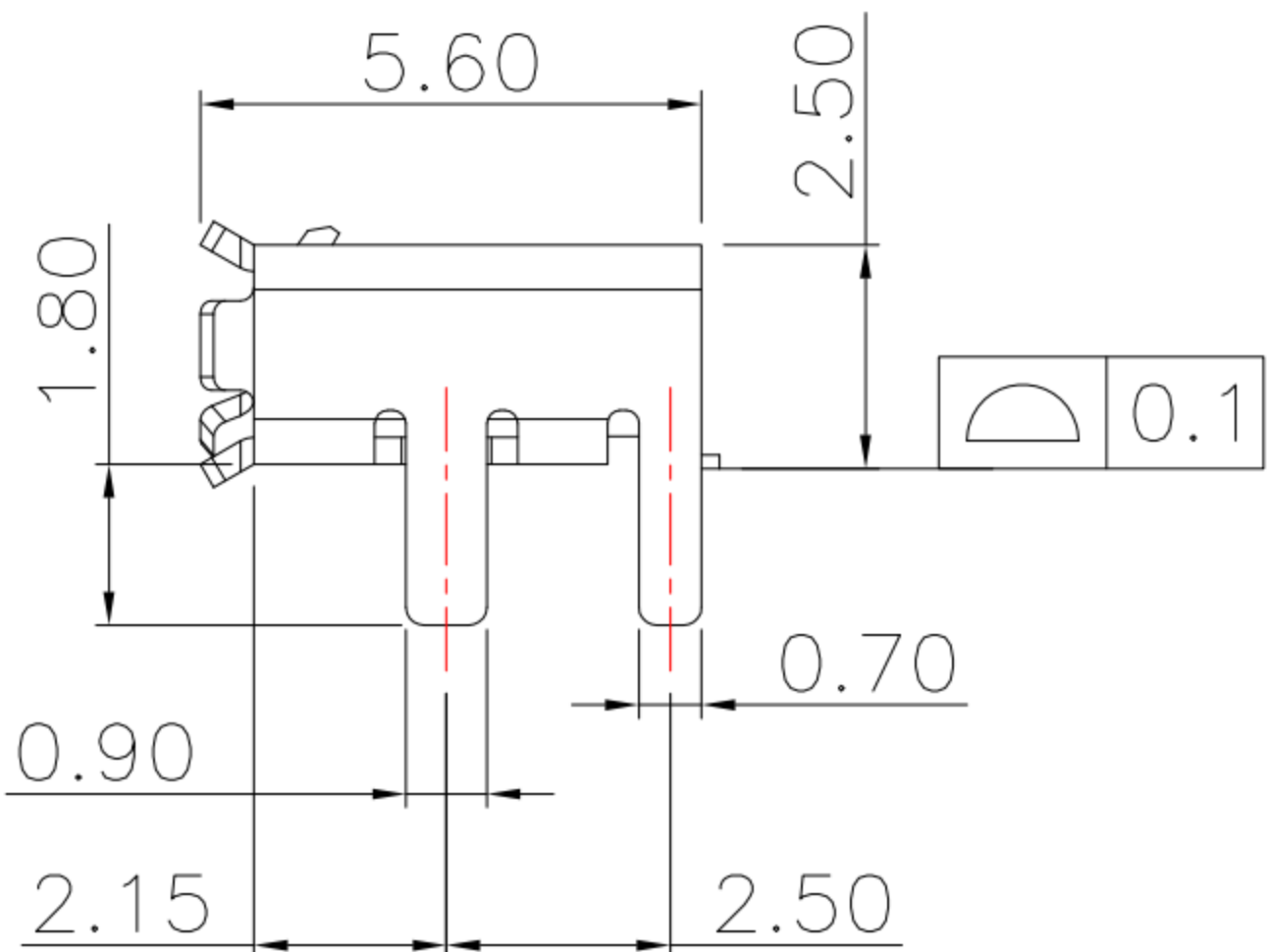
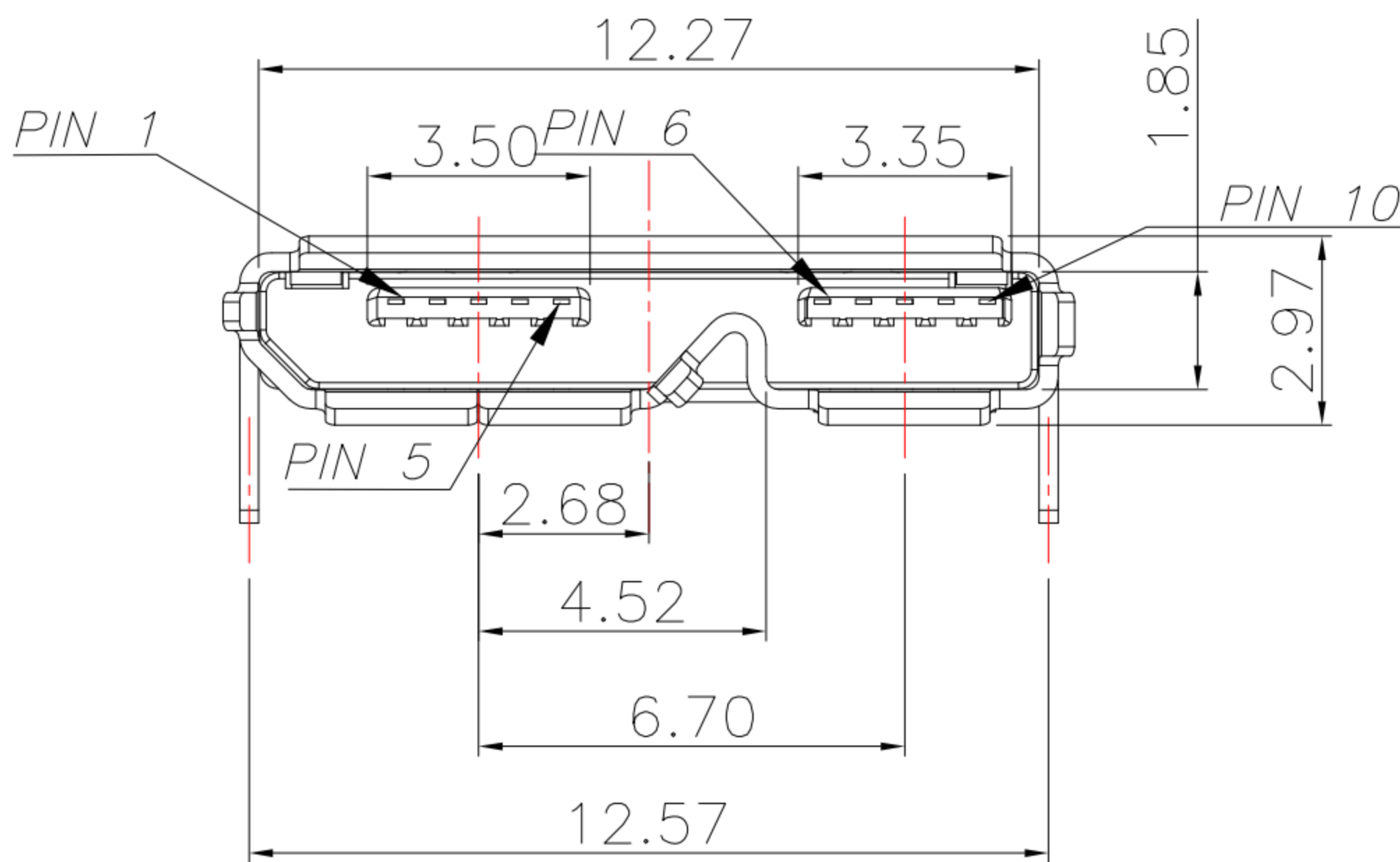
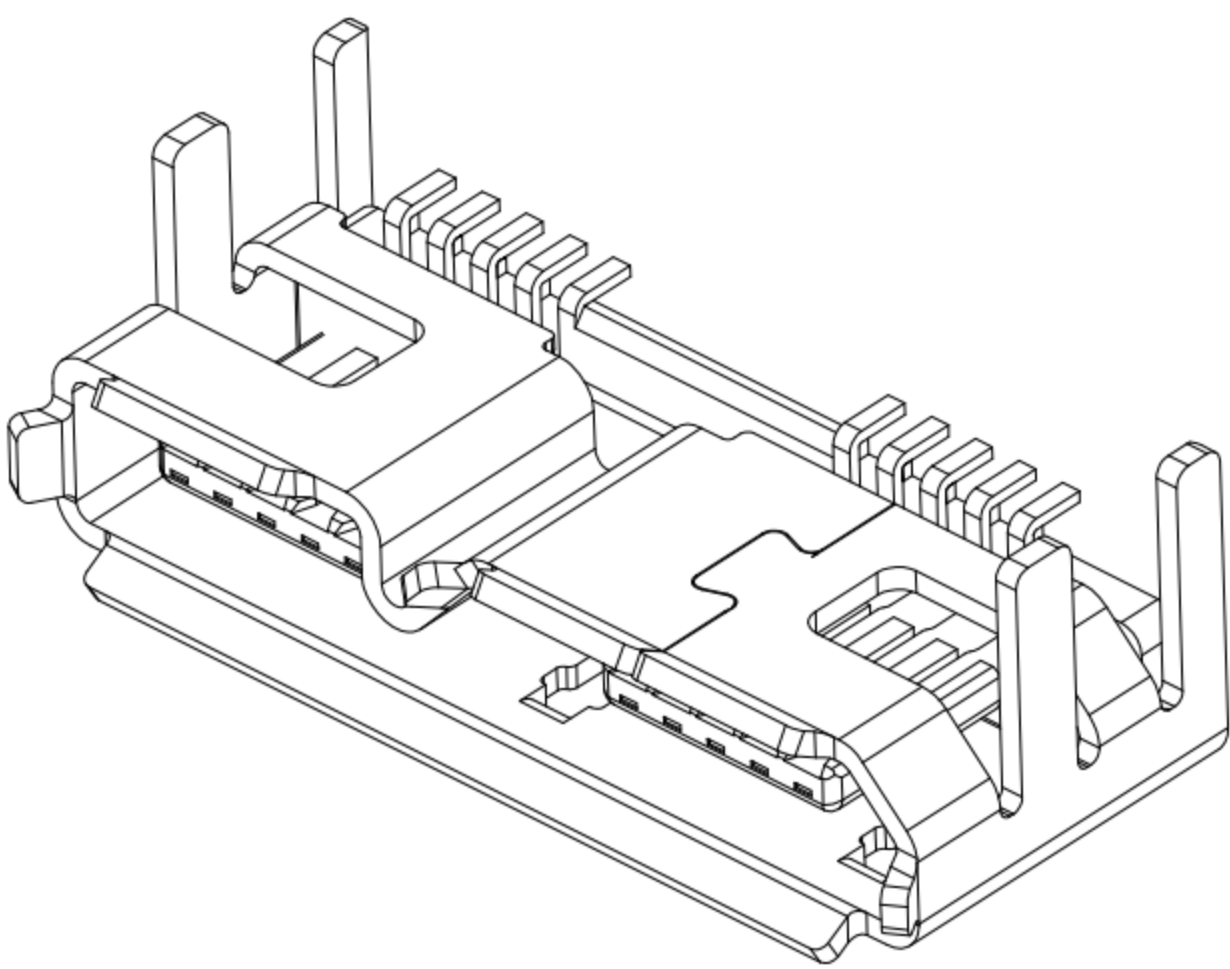
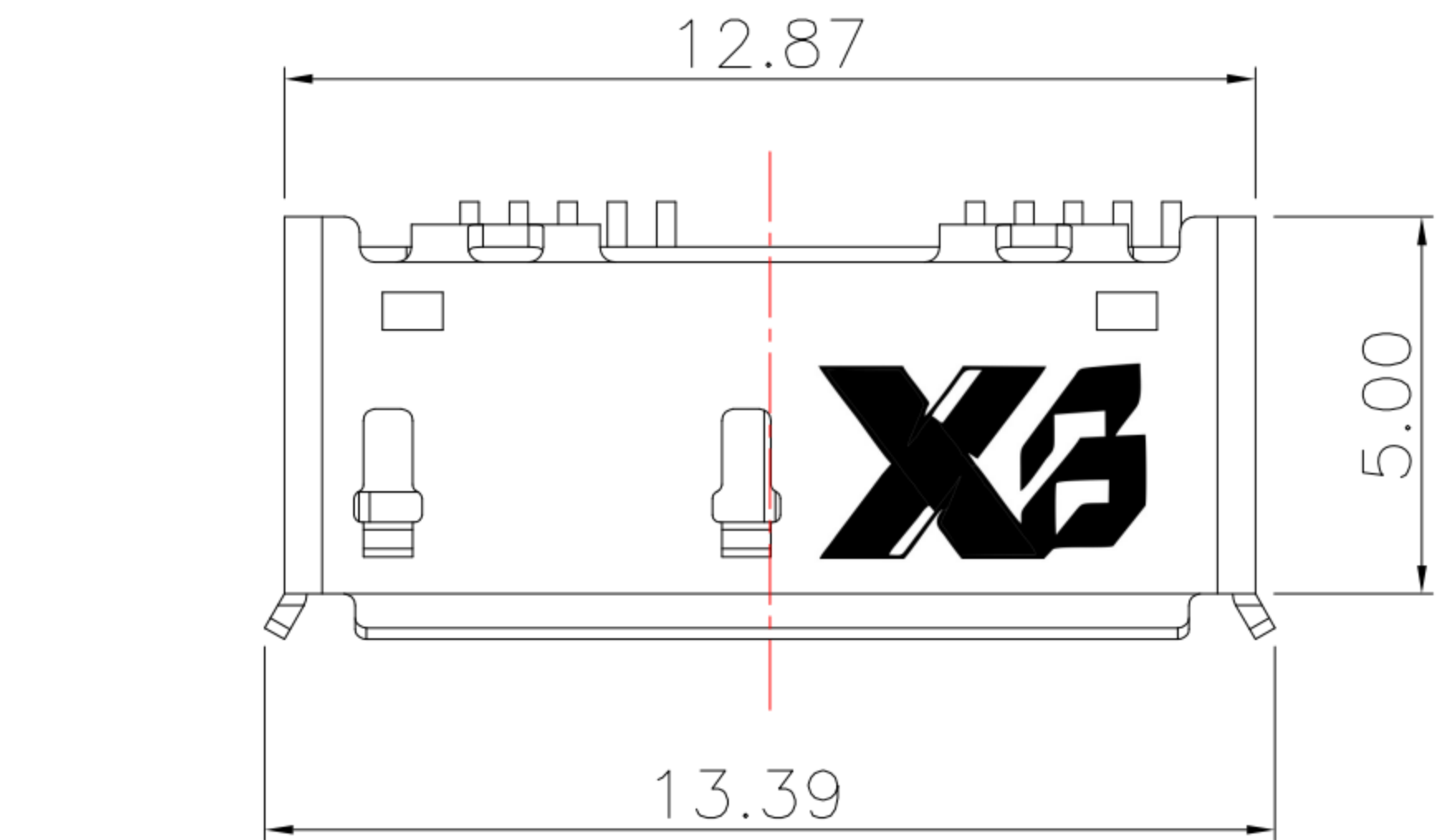




MRUSB-10B-D4-30x-S277

鍍層厚度：

Blank : 1u"
2 : 15u"
3 : 30u"



NOTE:

1.MATERIAL:

- 1.1 INSULATOR: LCP, UL 94V-0
- 1.2 CONTACT: BRASS
- 1.3 SHELL: SUS 304

2.Finish:

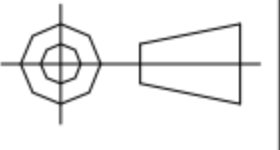
- 2.1 CONTACT: PLATED GOLD IN MATING AREA ;
TIN PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL

- 2.2 SHELL: NICKEL UNDER PLATED SURFACE LAYER



东莞市溪榜电子有限公司

DONG GUAN XI BANG ELECTRONICS CO., LTD

TOLERANCE UNLESS OTHERWISE STATED :		Up to 5 Above 5 ~ 15 Above 15 ~ 30 Above 30 ~ 50 Angle	±0.2 ±0.3 ±0.4 ±0.5 ±0.3°	3RD. ANGEL'S		UNITS	MM
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DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR	
Jack Lu	03/13/15				
CHECKED BY:	DATE	FINISH	MODLE	MICRO USB 3.0 B 型 母座 SMT 外壳 4脚 DIP	
Jacky Chen	03/13/15	SCALE	1 : 1	DWG NO.	MRUSB-10B-D4-30x-S277
APPROVED BY:	DATE	SHEET NO.	1 of 1	PART NO.	MRUSB-10B-D4-30x-S277
Tony Kao	03/13/15				
				SIZE	A4
				VER	R1

1	新增pin定義	Jack	031315
ITEM NO.	DESCRIPTION	DRAWN	DATE